



Patent
Docket No: 53434US009

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of:

Peter B. Hogerton, Kevin Y. Chen,
Joel A. Gerber and Robert L.D. Zenner

Serial No.: 09/690,600

Group Art Unit: 3729

Filed: October 17, 2000

Examiner:

For: SOLVENT ASSISTED BURNISHING
OF PRE-UNDERFILLED SOLDER-
BUMPED WAFERS FOR FLIPCHIP BONDING

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, DC 20231 on:

8-21-01

Signature

Tom Sanders

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
Washington, DC 20231

Dear Sir:

Pursuant to 37 C.F.R. §§ 1.97 and 1.98, enclosed please find a completed Form PTO-1449 citing references submitted for consideration during examination of the above-referenced patent application. A copy of each of the references cited therein is also enclosed.

Under 37 C.F.R. § 1.97(e)(1), I hereby certify that each item of information contained in this Supplemental Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three (3) months prior to the filing of this Supplemental Information Disclosure Statement.

Under 37 C.F.R. § 1.704(d), I hereby state that each item of information contained in this Supplemental Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart application and that this communication was not received by any individual designated in §1.56(c) more than thirty (30) days prior to the filing of this Supplemental Information Disclosure Statement.

A copy of a Search Report from a counterpart PCT application is enclosed.

It is respectfully requested that the Examiner initial and return the enclosed Form

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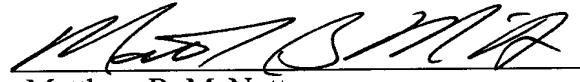
TECHNOLOGY CENTER R3700

PTO-1449 in order to indicate that each of the references listed thereon has been considered in connection with the present application.

Registration Number 39,766	Telephone Number 512-984-3958
Date <i>8/17/01</i>	

Respectfully submitted,

By



Matthew B. McNutt

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